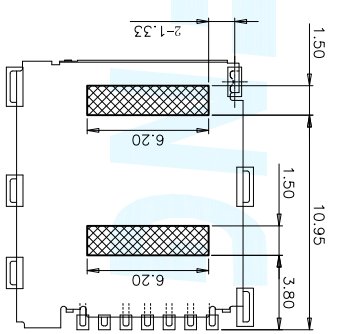
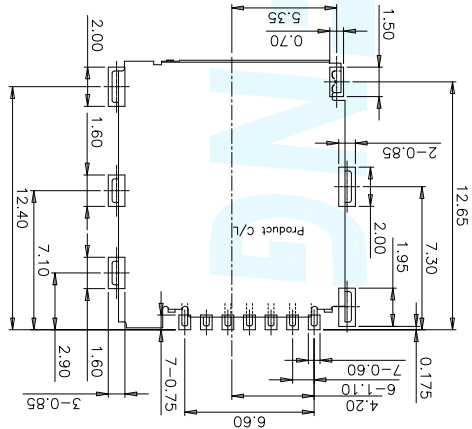
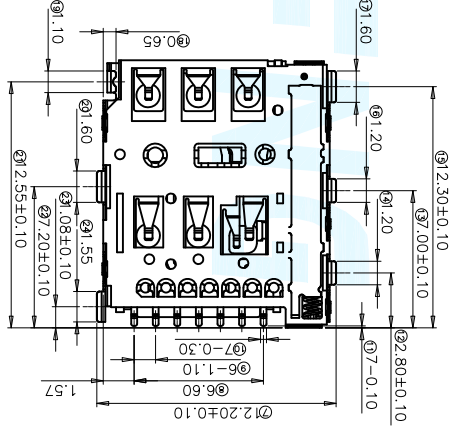
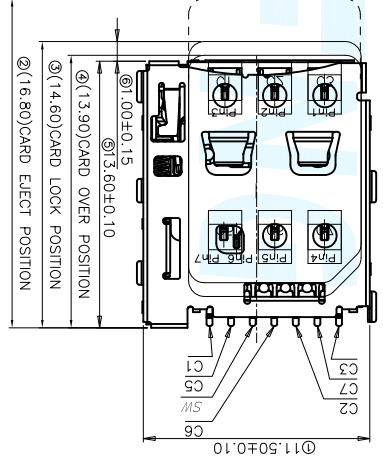
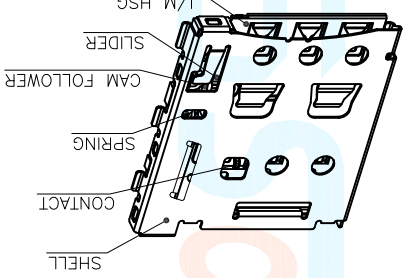
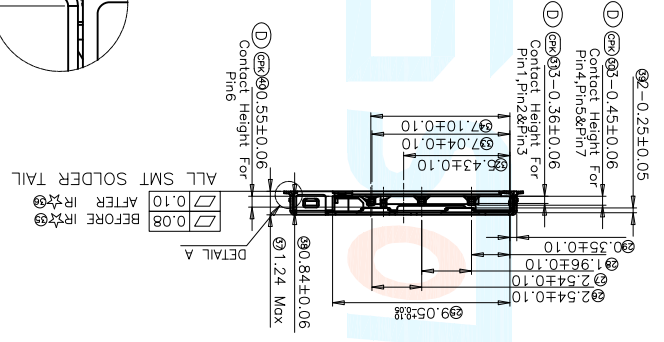


REV	ECN NO OR DESCRIPTION	REVISED	DATE
△	ALLEN	2015.06.04	



Connector Pin Assignment

No.	Pin Name	Description
①	C1	Vcc of SIM
②	C2	RST of SIM
③	C3	CLK of SIM
④	C5	GND of SIM
⑤	C6	Vpp of SIM
⑥	C7	I/O of SIM
⑦	SW	Detection Switch



DETAIL A
SCALE 15:1

- NOTES:
- 1-1. CONTACT: CONTACT AREA: Au 15u" Min.
 - 1-2. SHELL: GOLD FLASH PLATING ON SOLDER AREA
 2. ELECTRICAL REQUIREMENTS:
 - 2-1. CURRENT RATING: 0.5A PER PIN.
 - 2-2. CONTACT RESISTANCE: 50 mohm MAX.
 - 2-3. INSULATION RESISTANCE: 1000 MOHM MIN.200 VDC FOR 1 MINUTE.
 - 2-4. WITHSTANDING STRENGTH: 500V AC FOR 1 MINUTE.
 3. MECHANICAL REQUIREMENTS:
 4. ENVIRONMENT REQUIREMENTS:
 - 4-1. OPERATING TEMP: -30°C TO +85°C
 - 4-2. STORAGE TEMPERATURE: -40°C TO +85°C
 5. RECOMMENDED PROCESS DONDITION:
 - IR-REFLOW, PEAK TEMPERATURE AND TIME: 250°C, 5~10 S.

ITEM	PART NAME	MATERIAL	Q'TY	DISCRPTION
1	CONTACT	C7035-XS	1	Plating 50u"~200u" Ni over all. Plating 15u" Min. Au at switch area; Plating 3u" Min. Au at solder area;
2	I/M HSG	LCP SZ6505	1	BLACK COLOR, UL94 V-0
3	SHELL	SUS301-H	1	Plating Ni 10~50u" over all SOLDER AREA Plating Au 3u" Min
4	SLIDER	SUS301-2/1H+HTN	1	NO PLATING?BLACK COLOR
5	CAM FOLLOWER	SUS304-H	1	NO PLATING;
6	SPRING	SUS301-H	1	NO PLATING;

UNLESS OTHERWISE SPECIFIED TOLERANCES DECIMALS: ANGLES: X:XX :±0.10 X:X :±0.20 X:X :±1° X:XX :±0.10

SOFNG 东莞市硕方电子科技有限公司

APVD ERIC.W SIZE: A3 SHEET:10F 1 REV: A2

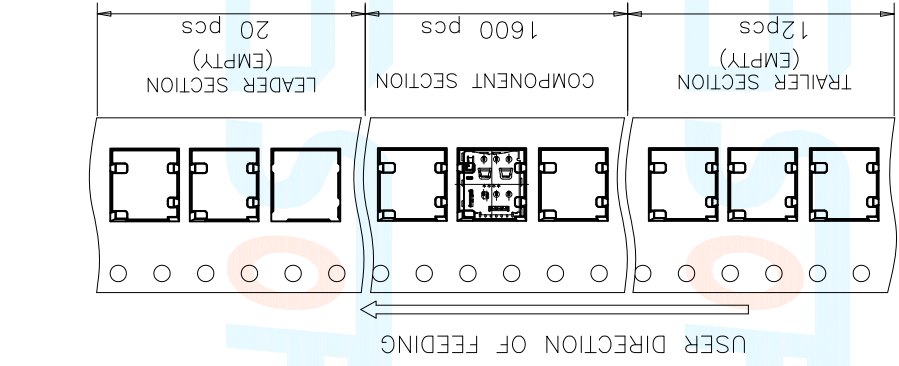
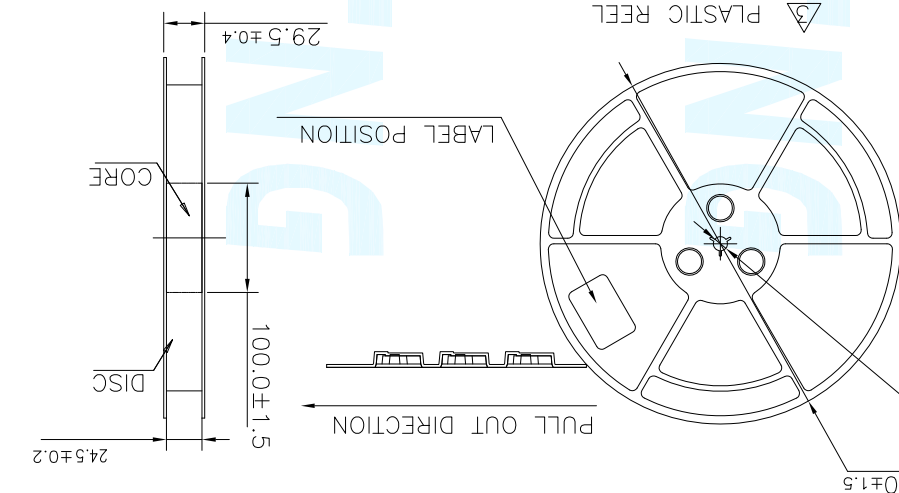
CHKD KEVIN SCALE:1:1 UNIT: mm

DWN ALLEN PART NO. SMO-1309-T

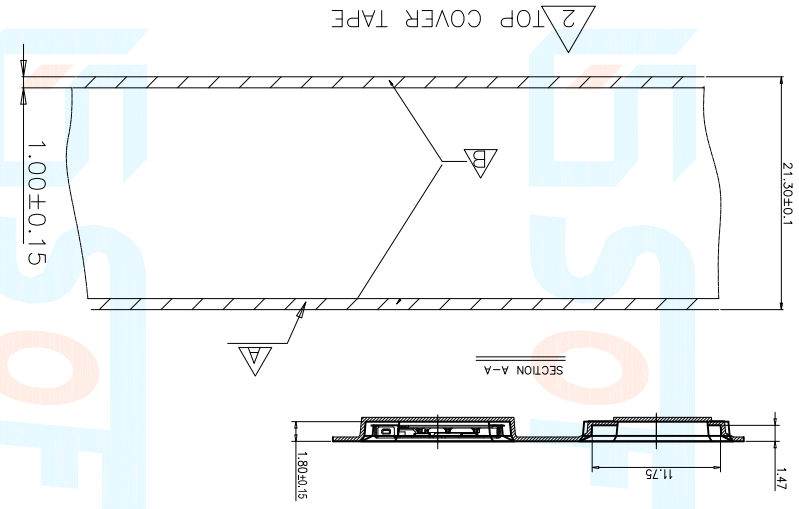
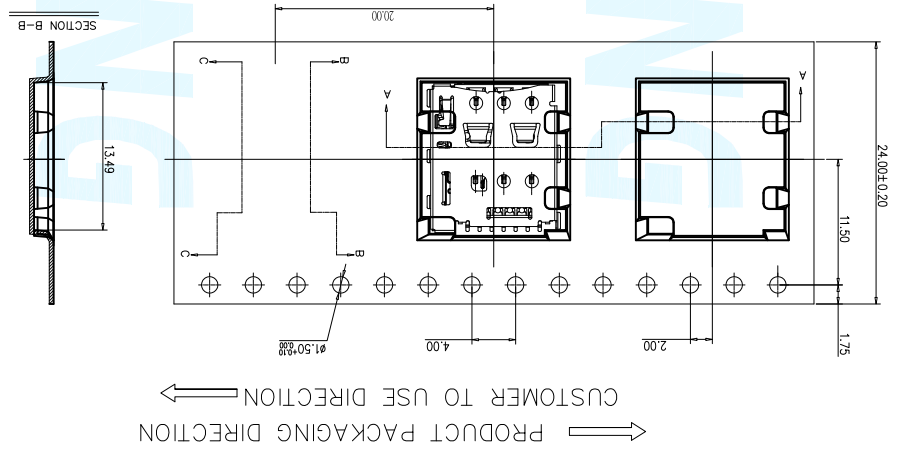
TITLE 6Pin 12H PUSH Nano SIM CARD CONN.

CUSTOMER COPY

REV.	ECN NO OR DESCRIPTION	REVISED	DATE
1	ALLEN	2015.06.04	



UNLESS OTHERWISE SPECIFIED TOLERANCES		SOFENG 东莞市硕方电子科技有限公司	
DECIMALS:	ANGLES:	TITLE	6Pin 1.2H PUSH NANO SIM CARD CONN.
X: ±0.5	X: ±2'	DWN	ALLEN
X.X: ±0.20	X.X: ±1'	CHKD	KEVIN
X.XX: ±0.10		APVD	ERIC.W
		SIZE:	A3
		SHEET:	10F 1
		REV:	A2
		PART NO.	SNO-1309-1
		CUSTOMER COPY	



- NOTES:
- CARRIER TAPE MATERIAL: THERMOPLASTIC ANTI-STATIC FILM OR EQUIVALENT
THICKNESS: 0.40±0.03 mm, COLOR: TRANSPARENT
 - TOP COVER TAPE MATERIAL:
THICKNESS: 0.10mm MAX.
 - BASE FILM: CONDUCTIVE OR EQUIVALENT.
 - PSA (PRESSURE SENSITIVE ADHESIVE) ON ONE SIDE OF THE BASE FILM.
DISC THICKNESS: 2.5mm
CORE THICKNESS: 16.5mm
 - PLASTIC REEL MATERIAL: HIGH IMPACT POLYSTYRENE (CONDUCTIVE)
 - PACKING QUANTITY: 1600pcs/REEL
COLOR: BLUE
 - THE DESIGN MEETS EIA-481-C EXCEPT OTHERWISE SPECIFIED.
 - THE DIMENSIONING SHALL BE INTERPRETED PER ASME Y14.5M-1994.
 - HARMFUL MATERIAL CONTROL PLEASE FOLLOW DOC:NO."EP112".

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